

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
AKIHIRO HASHIMOTO	05/28/2015
TADASHI IIDA	05/28/2015
KIYOMI KAWAMURA	06/01/2015
KOICHI MITAMURA	06/02/2015
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14741924
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NAME OF SUBMITTER:	WILLIAM E. LYDDANE

SIGNATURE:	/William E. Lyddane/
DATE SIGNED:	06/17/2015
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 6 source=P47698_assign#page1.tif source=P47698_assign#page2.tif source=P47698_assign#page3.tif source=P47698_assign#page4.tif source=P47698_assign#page5.tif source=P47698_assign#page6.tif	

COMBINED INVENTOR'S DECLARATION AND ASSIGNMENT

DECLARATION

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization to Permit Access to Application by Participating Office

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

Direct Correspondence to: **CUSTOMER NUMBER 07055**

At: Greenblum & Bernstein, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191

Direct Telephone Calls to: Greenblum & Bernstein, P.L.C. (703) 716-1191

ASSIGNMENT

WHEREAS, **Akihiro HASHIMOTO**, a resident of **Fukuoka, Japan**, whose mailing address is **c/o MITSUI HIGH-TEC, INC., 10-1, KOMINE 2-CHOME, YAHATANISHI-KU, KITAKYUSHU-SHI, FUKUOKA 807-8588 JAPAN**, and **Tadashi IIDA**, a resident of **Fukuoka, Japan**, whose mailing address is **c/o MITSUI HIGH-TEC, INC., 10-1, KOMINE 2-CHOME, YAHATANISHI-KU, KITAKYUSHU-SHI, FUKUOKA 807-8588 JAPAN**, and **Kiyomi KAWAMURA**, a resident of **Osaka, Japan**, whose mailing address is **c/o PANASONIC CORPORATION, 1006, OAZA KADOMA, KADOMA-SHI, OSAKA 571-8501, JAPAN**, and **Koichi MITAMURA**, a resident of **Osaka, Japan**, whose mailing address is **c/o PANASONIC CORPORATION, 1006, OAZA KADOMA, KADOMA-SHI, OSAKA 571-8501, JAPAN**, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

METHOD FOR MANUFACTURING LAMINATED IRON CORE

for which they have jointly executed, on the same date as this assignment, an application for Letters Patent for the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the practitioners of record in this application associated with Customer No. **07055** including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043, William E. Lyddane, Reg. No. 41,568 and William S. Boshnick, Reg. No. 44,550, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

AND WHEREAS, **MITSUI HIGH-TEC, INC.**, a corporation organized and existing under the laws of **Japan**, whose mailing address is **10-1, KOMINE 2-CHOME, YAHATANISHI-KU, KITAKYUSHU-SHI, FUKUOKA 807-8588 JAPAN**, and **PANASONIC CORPORATION**, a corporation organized and existing under the laws of **Japan**, whose mailing address is **1006, OAZA KADOMA, KADOMA-SHI, OSAKA 571-8501, JAPAN**, hereinafter known as the ASSIGNEES, are desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

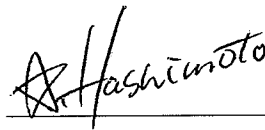
NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEES, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States and including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights

to sue for past and future infringement thereunder, said ASSIGNEES and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEES and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

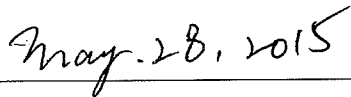
AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEES, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEES, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the date indicated below.



Akihiro HASHIMOTO



Date

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the date indicated below.

J. Iida

Tadashi IIDA

May. 28, 2015

Date

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IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the date indicated below.

Kiyomi Kawamura

Kiyomi KAWAMURA

Date June 1, 2015

<<File Number>>

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IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the date indicated below.

Koichi Mitamura

Koichi MITAMURA

Date Jun 2, 2015

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